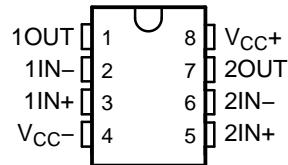


FEATURES

- Continuous Short-Circuit Protection
- Wide Common-Mode and Differential Voltage Ranges
- No Frequency Compensation Required
- Low Power Consumption
- No Latch-Up
- Unity-Gain Bandwidth . . . 3 MHz Typ
- Gain and Phase Match Between Amplifiers
- Low Noise . . . 8 nV/ $\sqrt{\text{Hz}}$ Typ at 1 kHz

**D, DGK, P, PS, OR PW PACKAGE
(TOP VIEW)**



DESCRIPTION/ORDERING INFORMATION

The RC4558 device is a dual general-purpose operational amplifier, with each half electrically similar to the μA741, except that offset null capability is not provided.

The high common-mode input voltage range and the absence of latch-up make this amplifier ideal for voltage-follower applications. The device is short-circuit protected, and the internal frequency compensation ensures stability without external components.

ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	MSOP/VSSOP – DGK	Reel of 2500	YR_ ⁽²⁾
	PDIP – P	Tube of 50	RC4558P
	SOIC – D	Tube of 75	RC4558D
		Reel of 2500	RC4558DR
	SOP – PS	Reel of 2000	RC4558PSR
	TSSOP – PW	Tube of 150	RC4558PW
		Reel of 2000	RC4558PWR
–40°C to 85°C	MSOP/VSSOP – DGK	Reel of 2500	YS_ ⁽²⁾
	PDIP – P	Tube of 50	RC4558IP
	SOIC – D	Tube of 75	RC4558ID
		Reel of 2500	RC4558IDR
	TSSOP – PW	Tube of 150	RC4558IPW
		Reel of 2000	RC4558IPWR

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) The actual top-side marking has one additional character that designates the assembly/test site.



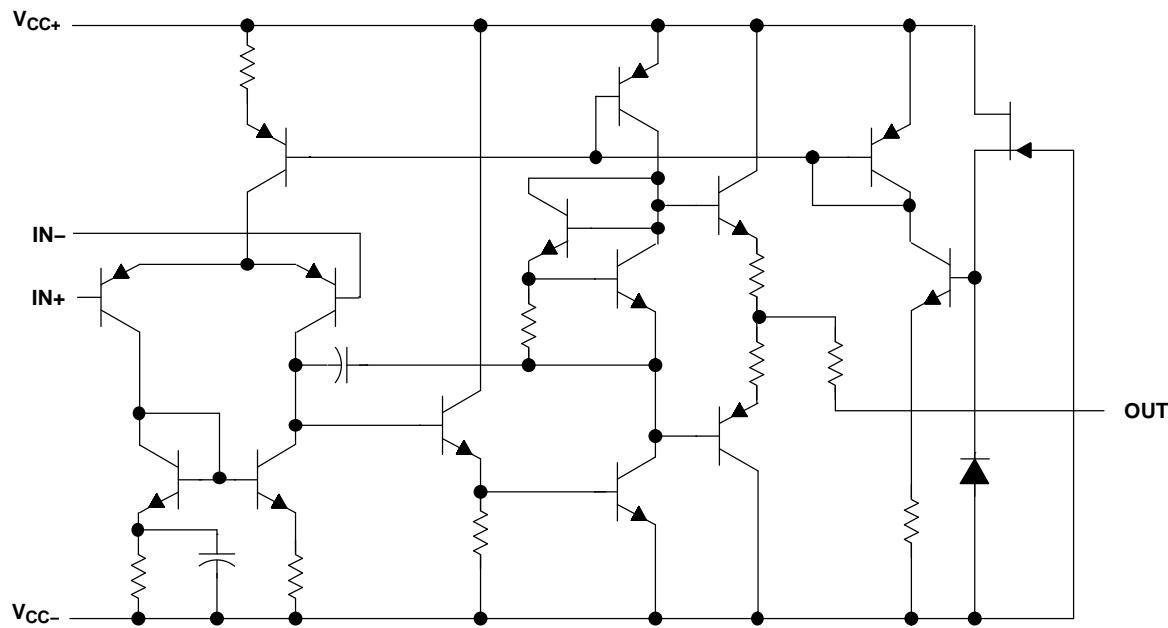
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

RC4558
DUAL GENERAL-PURPOSE OPERATIONAL AMPLIFIER

SLOS073E-MARCH 1976-REVISED FEBRUARY 2006

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SCHEMATIC (EACH AMPLIFIER)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{CC+}	Supply voltage ⁽²⁾		18	
V _{CC-}			-18	V
V _{ID}	Differential input voltage ⁽³⁾		±30	V
V _I	Input voltage (any input) ⁽²⁾⁽⁴⁾		±15	V
	Duration of output short circuit to ground, one amplifier at a time ⁽⁵⁾		Unlimited	
θ _{JA}	Package thermal impedance ⁽⁶⁾⁽⁷⁾	D package	97	°C/W
		DGK package	172	
		P package	85	
		PS package	95	
		PW package	149	
T _J	Operating virtual junction temperature		150	°C
T _{stg}	Storage temperature range	-65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, unless otherwise noted, are with respect to the midpoint between V_{CC+} and V_{CC-}.
- (3) Differential voltages are at IN+ with respect to IN-.
- (4) The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
- (5) Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
- (6) Maximum power dissipation is a function of T_J (max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_J (max) – T_A)/θ_{JA}. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (7) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions

		MIN	MAX	UNIT
V _{CC+}	Supply voltage	5	15	
V _{CC-}		-5	-15	V
T _A	Operating free-air temperature	RC4558	0	°C
		RC4558I	-40	

RC4558

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Electrical Characteristics

at specified free-air temperature, $V_{CC+} = 15 \text{ V}$, $V_{CC-} = -15 \text{ V}$

PARAMETER		TEST CONDITIONS ⁽¹⁾	$T_A^{(2)}$	MIN	TYP	MAX	UNIT
V_{IO}	Input offset voltage	$V_O = 0$	25°C	0.5	6		mV
			Full range		7.5		
I_{IO}	Input offset current	$V_O = 0$	25°C	5	200		nA
			Full range		300		
I_{IB}	Input bias current	$V_O = 0$	25°C	150	500		nA
			Full range		800		
V_{ICR}	Common-mode input voltage range		25°C	± 12	± 14		V
V_{OM}	Maximum output voltage swing	$R_L = 10 \text{ k}\Omega$	25°C	± 12	± 14		V
		$R_L = 2 \text{ k}\Omega$	25°C	± 10	± 13		
			Full range	± 10			
A_{VD}	Large-signal differential voltage amplification	$R_L \geq 1\text{k}\Omega$, $V_O = \pm 10 \text{ V}$	25°C	20	300		V/mV
			Full range		15		
B_1	Unity-gain bandwith		25°C		3		MHz
r_i	Input resistance		25°C	0.3	5		MΩ
CMRR	Common-mode rejection ratio		25°C	70	90		dB
k_{SVS}	Supply-voltage sensitivity ($\Delta V_{IO}/\Delta V_{CC}$)	$V_{CC} = \pm 15 \text{ V}$ to $\pm 9 \text{ V}$	25°C		30	150	μV/V
V_n	Equivalent input noise voltage (closed loop)	$A_{VD} = 100$, $R_S = 100 \Omega$, $f = 1 \text{ kHz}$, $BW = 1 \text{ Hz}$	25°C		8		nV/√Hz
I_{CC}	Supply current (both amplifiers)	$V_O = 0$, No load	25°C	2.5	5.6		mA
			T_A min	3	6.6		
			T_A max	2.3	5		
P_D	Total power dissipation (both amplifiers)	$V_O = 0$, No load	25°C	75	170		mW
			T_A min	90	200		
			T_A max	70	150		
V_{O1}/V_{O2}	Crosstalk attenuation	Open loop	$R_S = 1 \text{ k}\Omega$, $f = 10 \text{ kHz}$	25°C	85		dB
		$A_{VD} = 100$			105		

(1) All characteristics are measured under open-loop conditions with zero common-mode input voltage, unless otherwise specified.

(2) Full range is 0°C to 70°C for RC4558 and -40°C to 85°C for RC4558I.

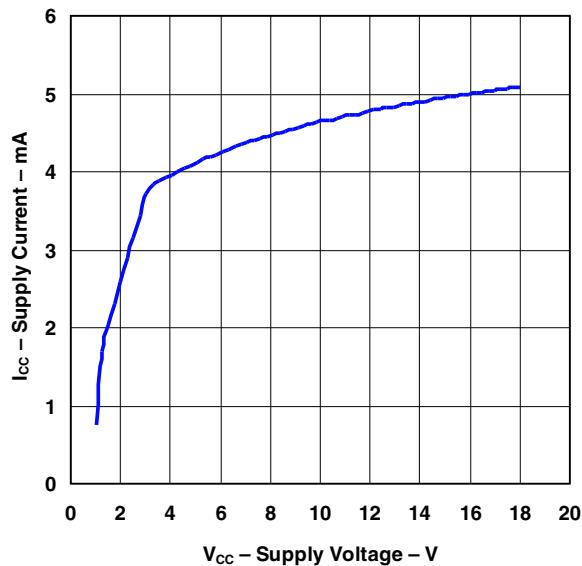
Operating Characteristics

$V_{CC+} = 15 \text{ V}$, $V_{CC-} = -15 \text{ V}$, $T_A = 25^\circ\text{C}$

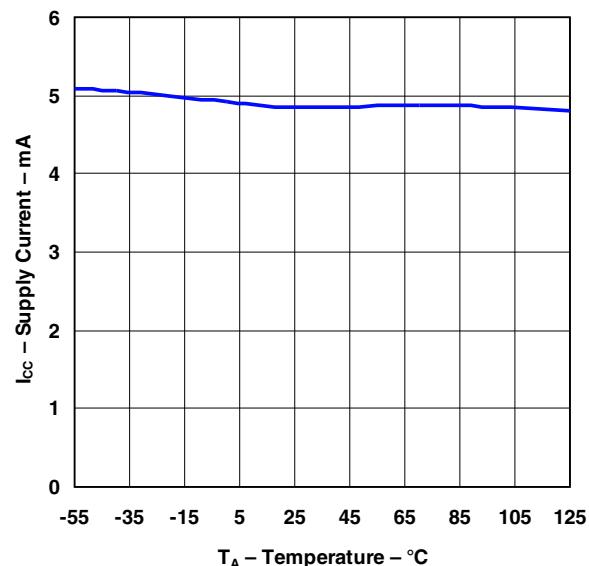
PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
t_r	Rise time	$V_I = 20 \text{ mV}$,	$R_L = 2 \text{ k}\Omega$,	$C_L = 100 \text{ pF}$		0.13		ns
Overshoot		$V_I = 20 \text{ mV}$,	$R_L = 2 \text{ k}\Omega$,	$C_L = 100 \text{ pF}$		5		%
SR	Slew rate at unity gain	$V_I = 10 \text{ V}$,	$R_L = 2 \text{ k}\Omega$,	$C_L = 100 \text{ pF}$	1.1	1.7		V/μs

TYPICAL CHARACTERISTICS

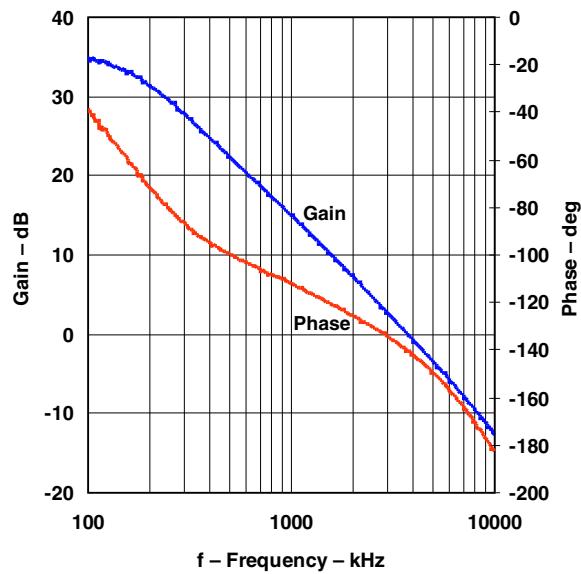
SUPPLY CURRENT
 vs
 SUPPLY VOLTAGE
 $(T_A = 25^\circ\text{C})$



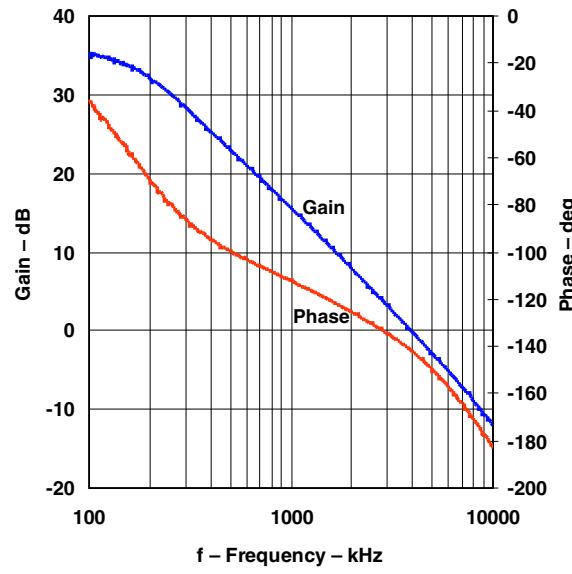
SUPPLY CURRENT
 vs
 TEMPERATURE
 $(V_{CC} = \pm 15 \text{ V})$



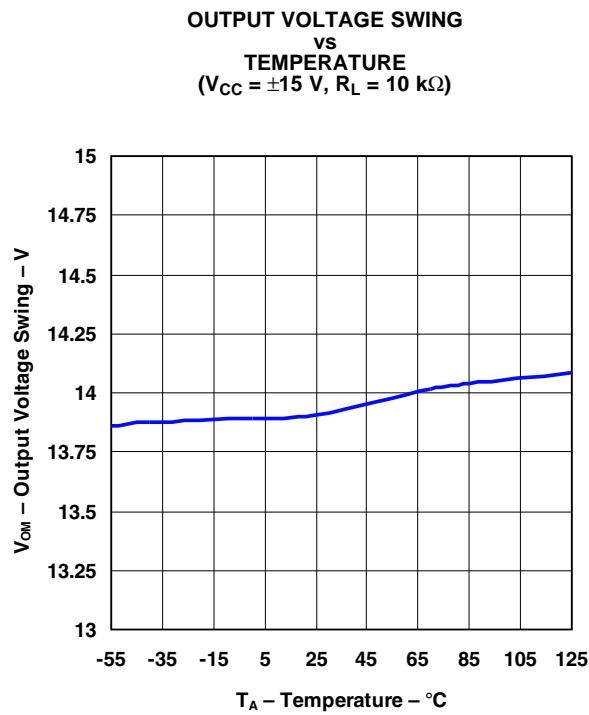
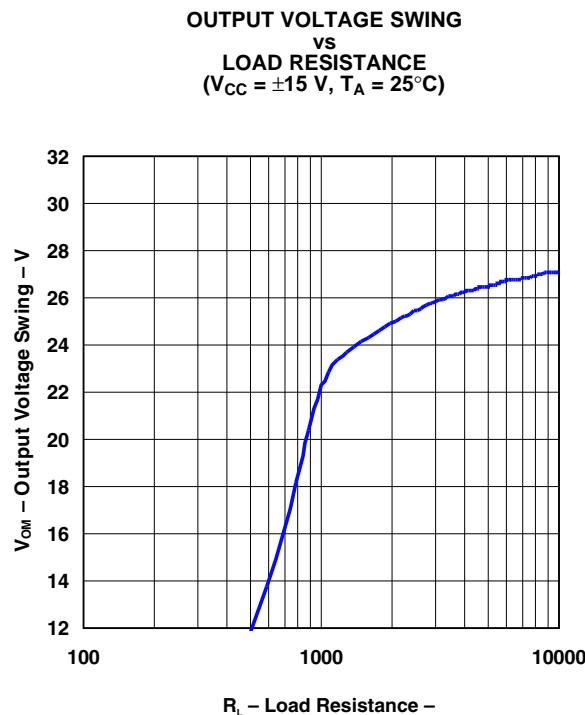
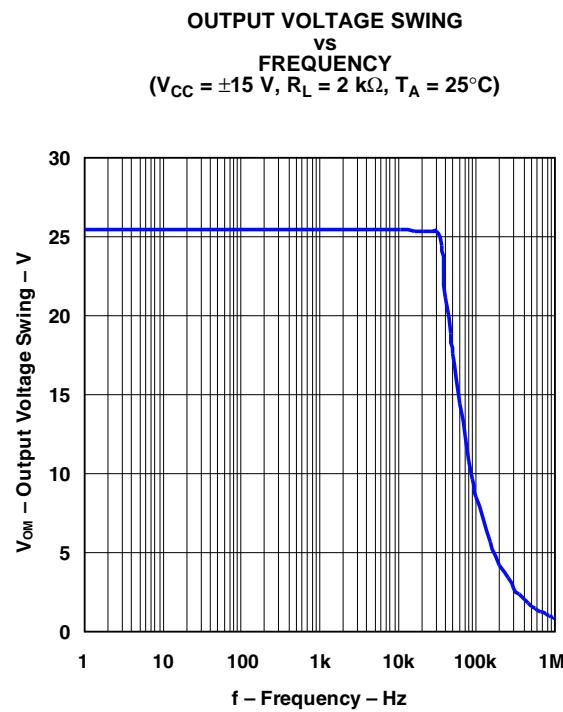
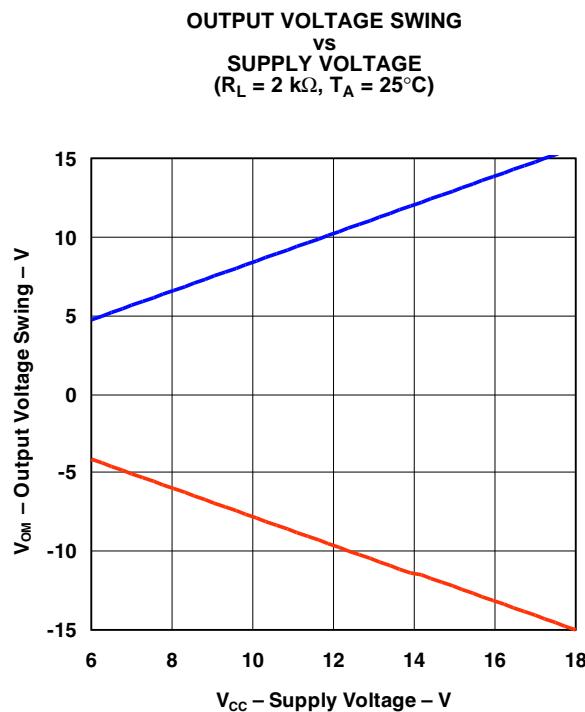
GAIN AND PHASE
 vs
 FREQUENCY
 $(V_{CC} = \pm 15 \text{ V}, R_L = 2 \text{ k}\Omega, C_L = 22 \text{ pF})$



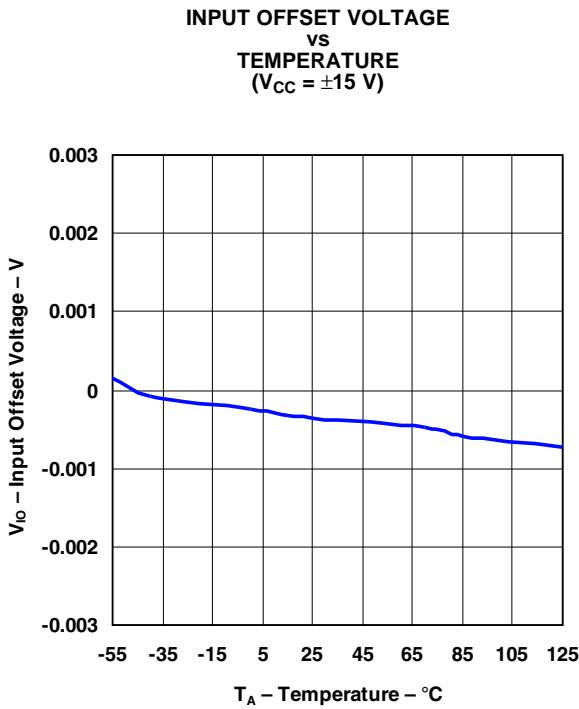
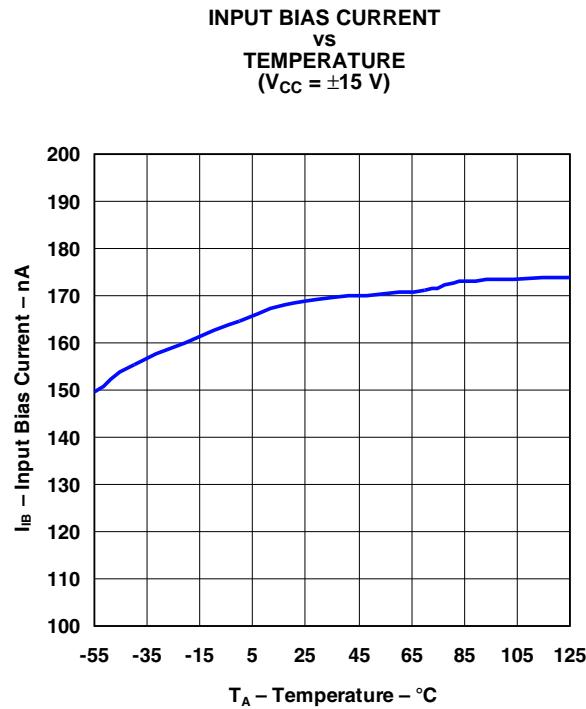
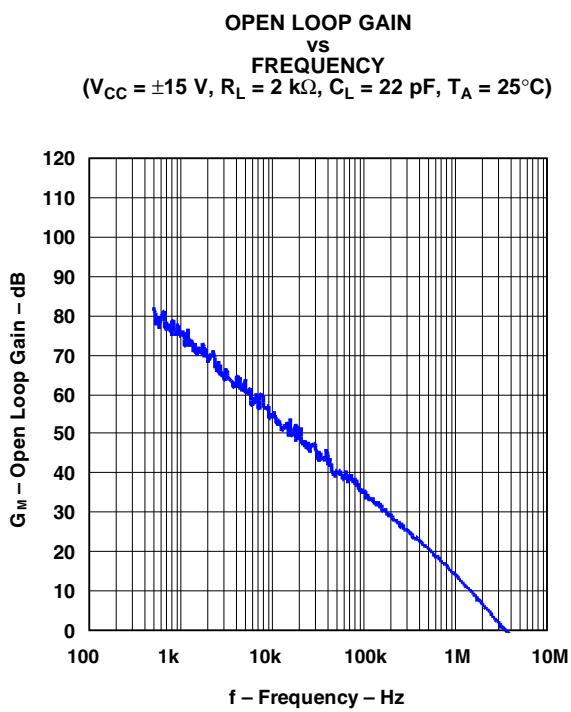
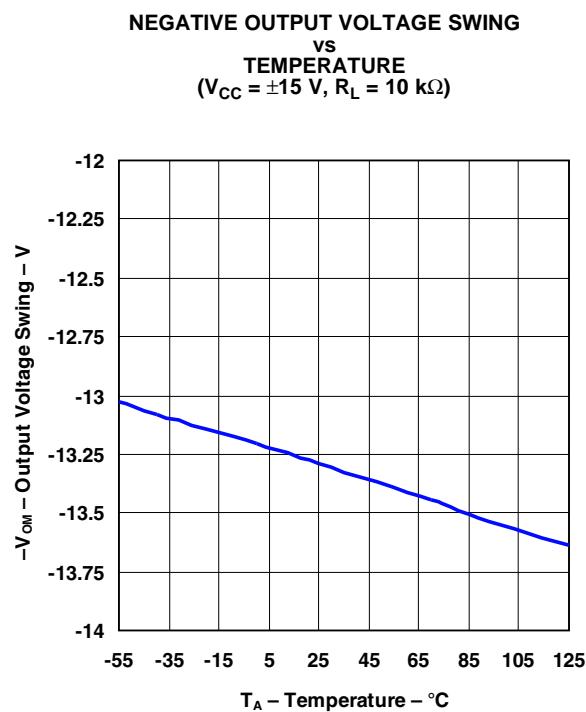
GAIN AND PHASE
 vs
 FREQUENCY
 $(V_{CC} = \pm 15 \text{ V}, R_L = 10 \text{ k}\Omega, C_L = 22 \text{ pF})$



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

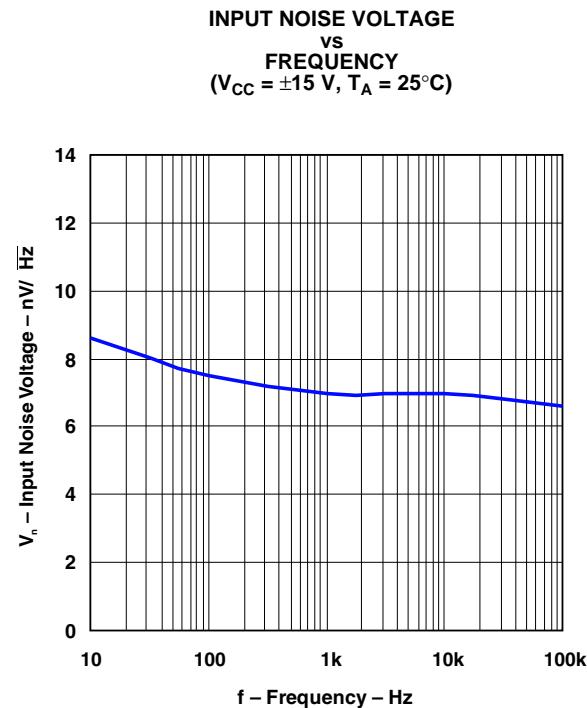


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TYPICAL CHARACTERISTICS (continued)





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
RC4558D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558DE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558DGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558DGKRG4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558DRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558DRG3	PREVIEW	SOIC	D	8	2500	TBD	Call TI	Call TI	Samples Not Available
RC4558DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558IDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558IDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558IDGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558IDGKRG4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558IDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office



PACKAGE OPTION ADDENDUM

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27-May-2010

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
RC4558IP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office
RC4558IPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office
RC4558IPW	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558IPWE4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558IPWG4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558IPWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558IPWRE4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558IPWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558P	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office
RC4558PE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office
RC4558PSLE	OBsolete	SO	PS	8		TBD	Call TI	Call TI	Samples Not Available
RC4558PSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558PSRE4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558PSRG4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558PW	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558PWE4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558PWG4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
RC4558PWLE	OBsolete	TSSOP	PW	8		TBD	Call TI	Call TI	Samples Not Available
RC4558PWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office



PACKAGE OPTION ADDENDUM

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27-May-2010

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
RC4558PWRE4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558PWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
RC4558Y	OBsolete	DIESALE	Y	0		TBD	Call TI	Call TI	Samples Not Available

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

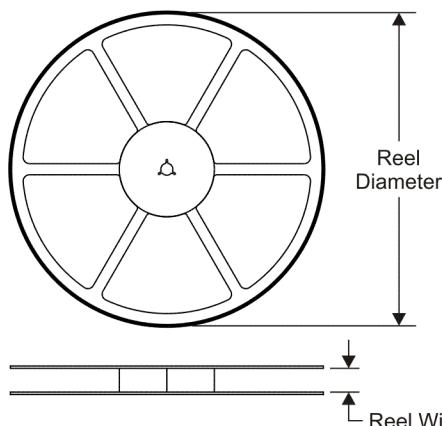
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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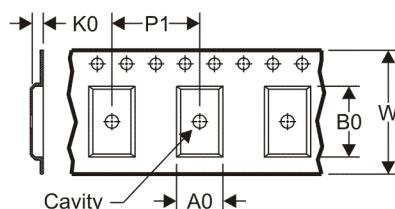
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

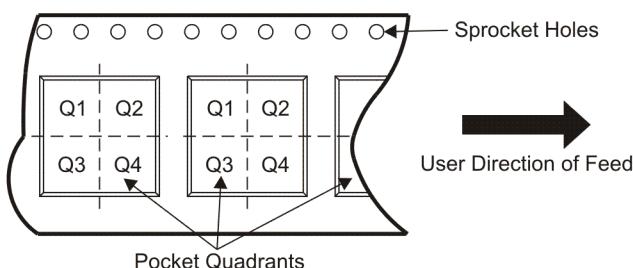


TAPE DIMENSIONS



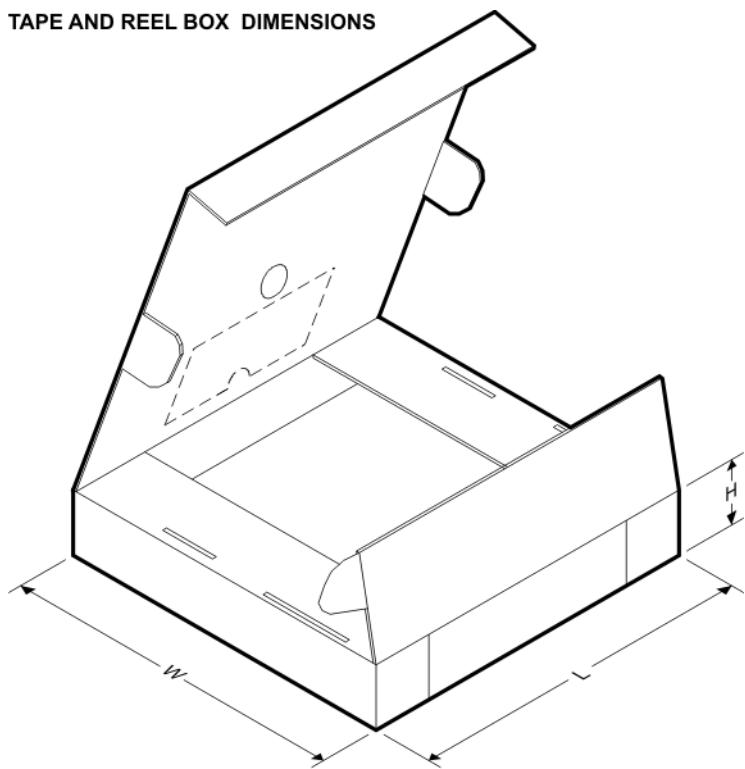
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
RC4558DGKR	MSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
RC4558DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
RC4558DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
RC4558IDGKR	MSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
RC4558IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
RC4558IPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
RC4558PSR	SO	PS	8	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
RC4558PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS


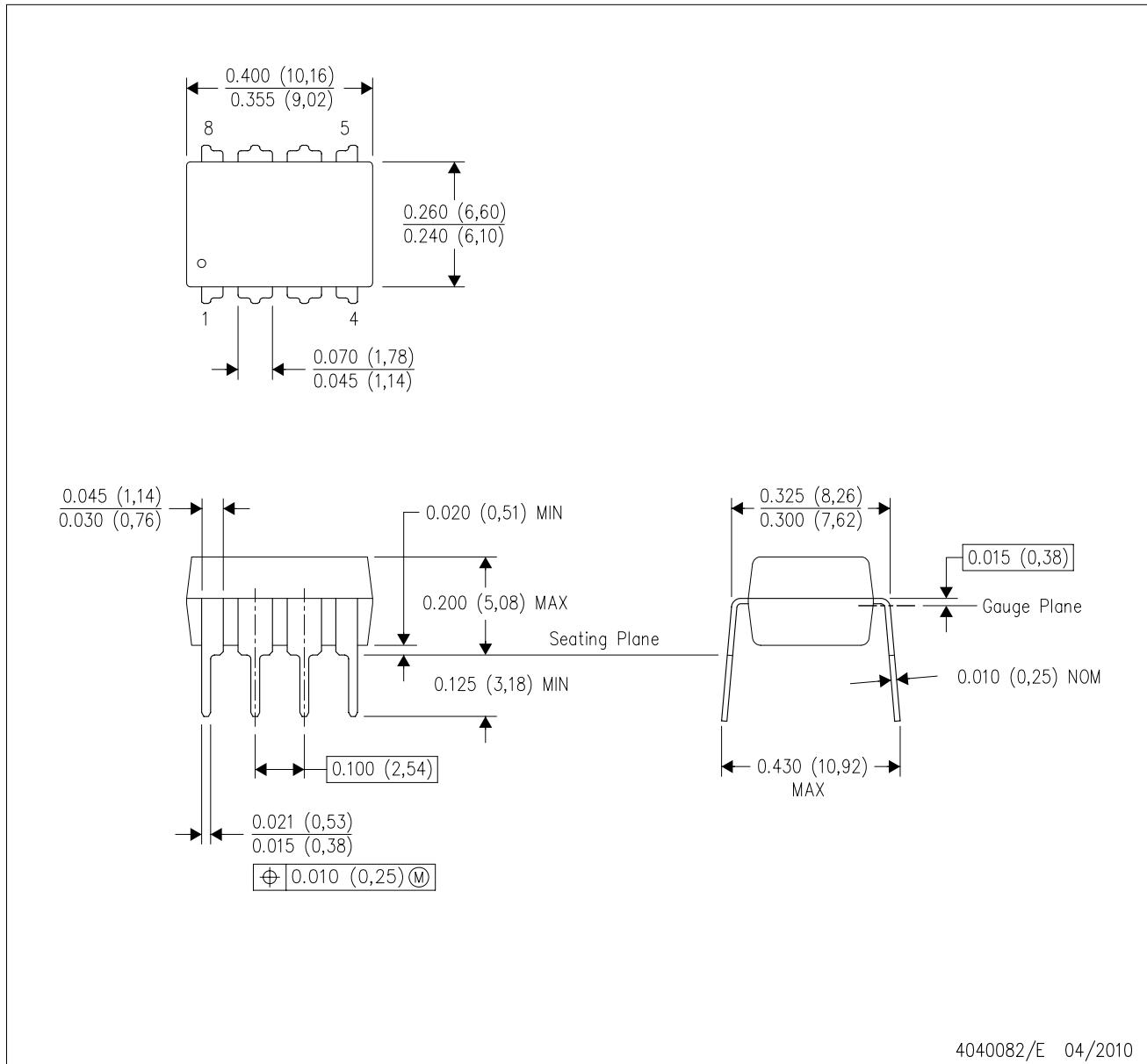
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
RC4558DGKR	MSOP	DGK	8	2500	358.0	335.0	35.0
RC4558DR	SOIC	D	8	2500	346.0	346.0	29.0
RC4558DR	SOIC	D	8	2500	340.5	338.1	20.6
RC4558IDGKR	MSOP	DGK	8	2500	358.0	335.0	35.0
RC4558IDR	SOIC	D	8	2500	340.5	338.1	20.6
RC4558IPWR	TSSOP	PW	8	2000	346.0	346.0	29.0
RC4558PSR	SO	PS	8	2000	346.0	346.0	33.0
RC4558PWR	TSSOP	PW	8	2000	346.0	346.0	29.0

MECHANICAL DATA

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE

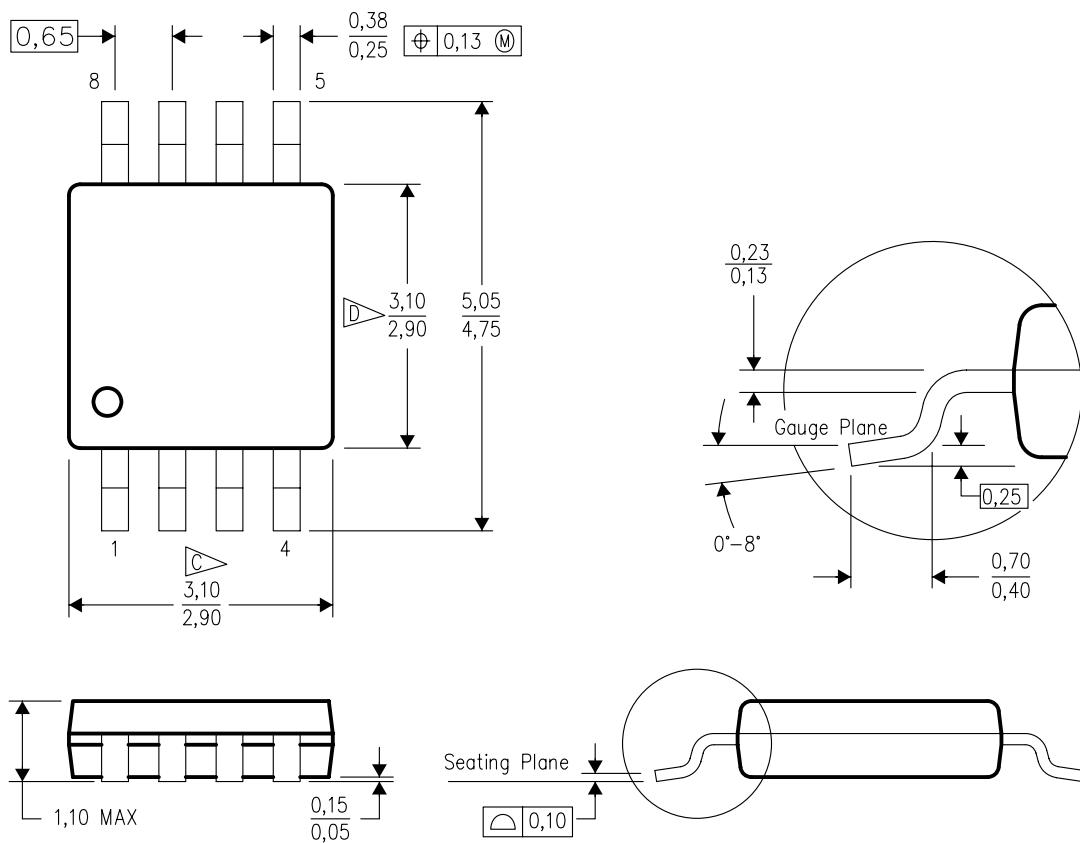


4040082/E 04/2010

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



4073329/E 05/06

NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

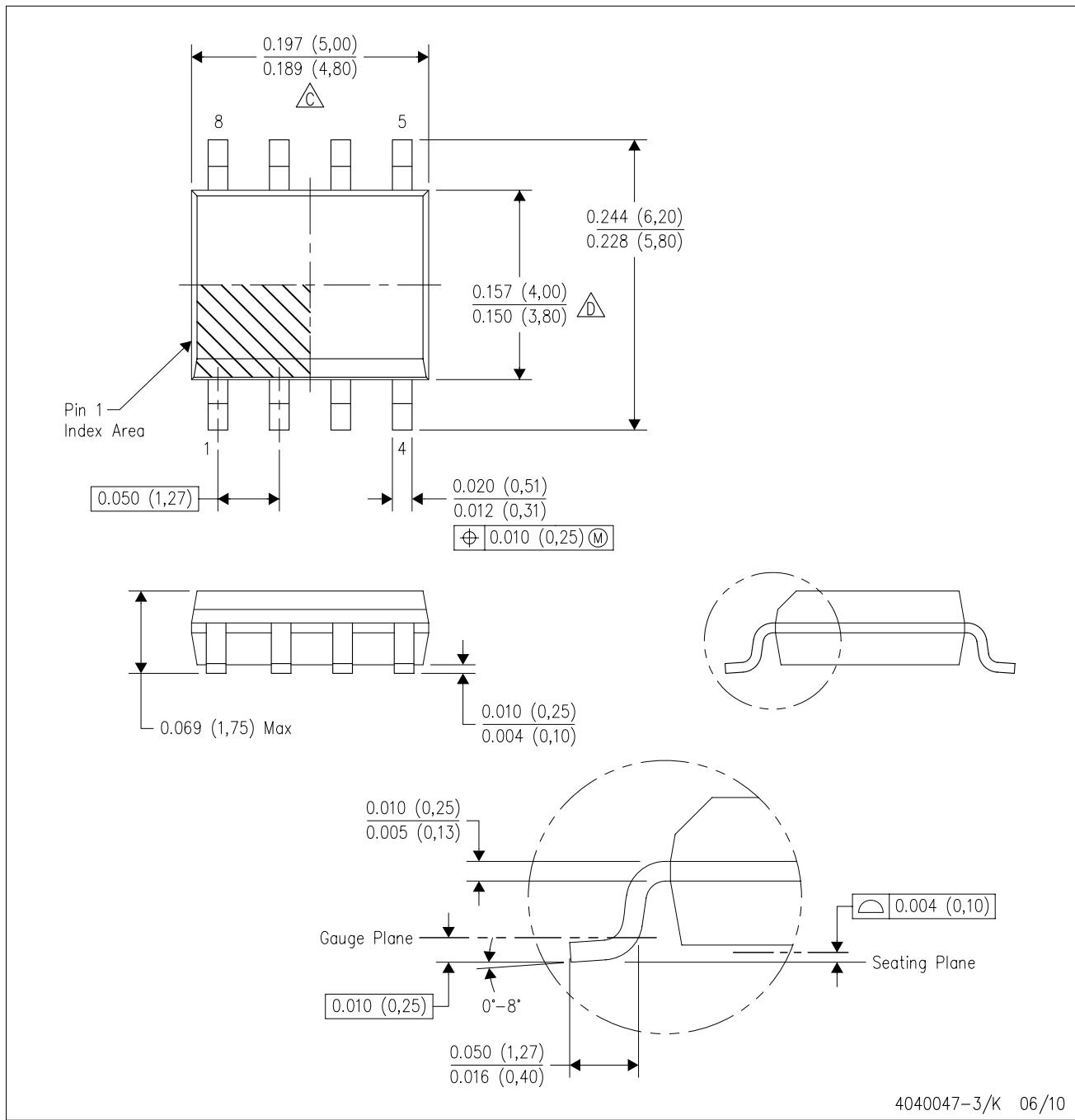
Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.

Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.

E. Falls within JEDEC MO-187 variation AA, except interlead flash.

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



4040047-3/K 06/10

NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

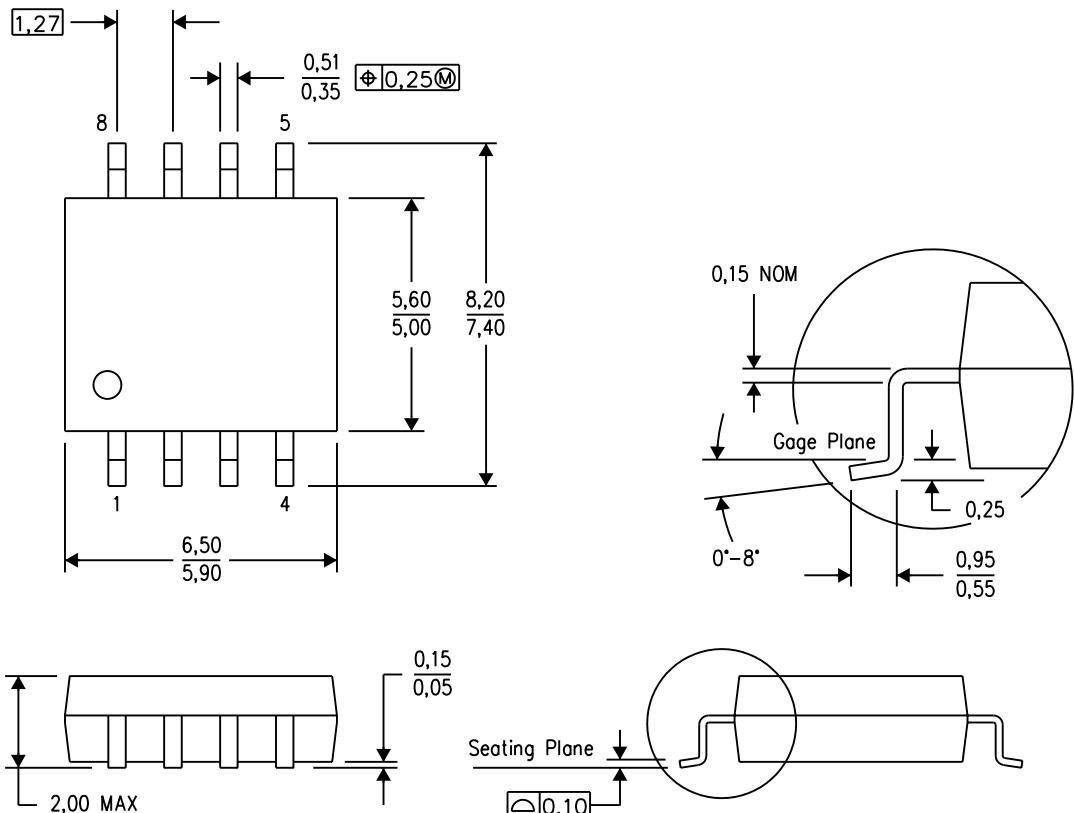
D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AA.

MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



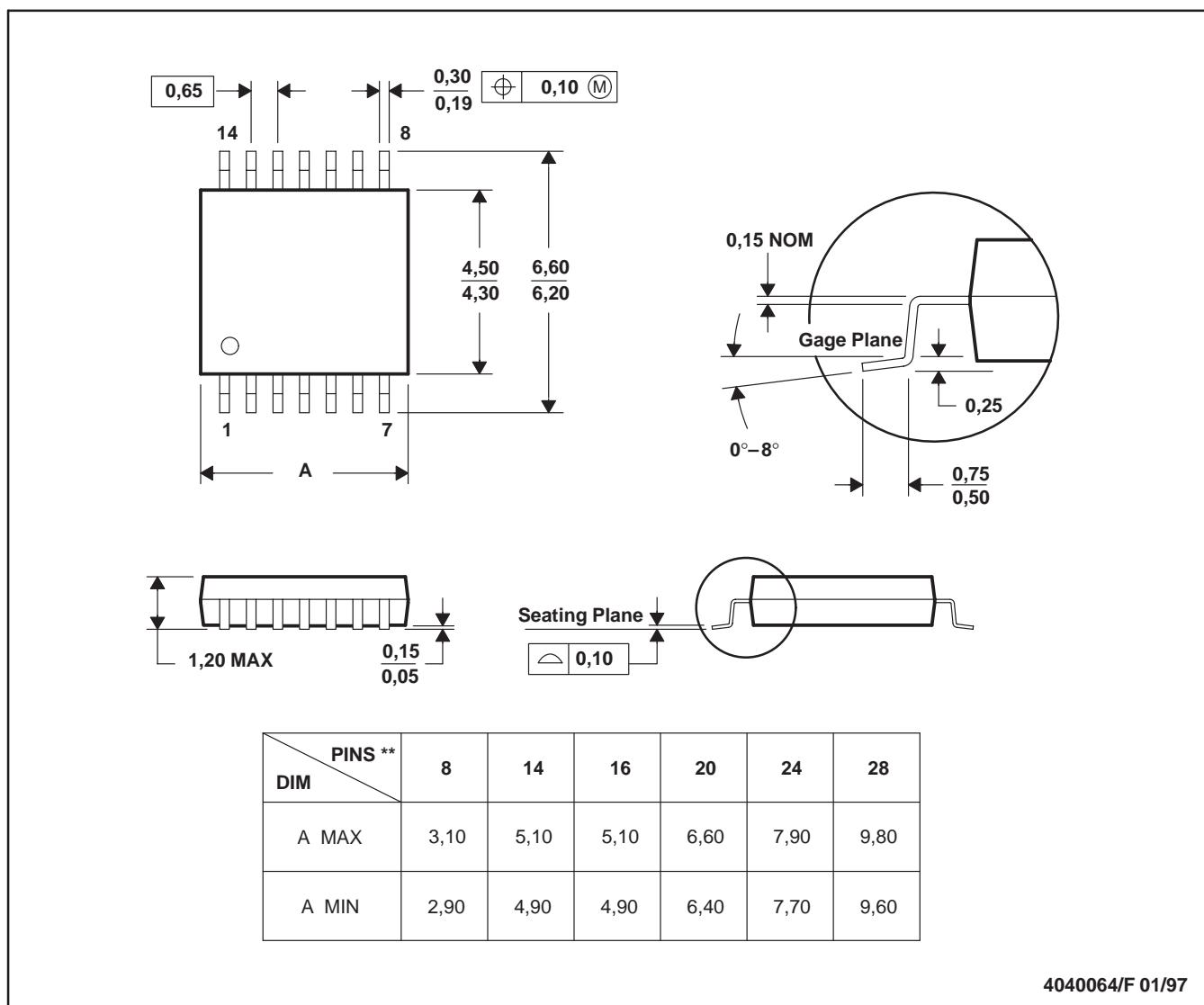
4040063/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - Falls within JEDEC MO-153

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